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DOCKET NO. P-3584

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Sheldon Aronowitz, Helmut Puchner, Ravindra A. Kapre, and James P.

Kimball

Assignee:

LSI Logic Corporation

Title:

FORMATION OF INTEGRATED CIRCUIT STRUCTURE USING ONE OR MORE SILICON LAYERS FOR IMPLANTATION AND

OUT-DIFFUSION IN FORMATION OF DEFECT-FREE SOURCE/DRAIN REGIONS AND ALSO FOR SUBSEQUENT

FORMATION OF SILICON NITRIDE SPACERS

Serial No.:

Unknown

5-11-98

Filed:

Herewith

Group Art Unit: Unknown

Attorney Docket No. P-3584

Examiner: Unknown

09/076399

May 11, 1998

## RECORDATION FORM COVER SHEET PATENTS ONLY

To the Honorable Commissioner of Patents and Trademarks Washington, DC 20231

Sir:

Please record the attached original documents or copy thereof.

Name of conveying party(ies): 1.

Sheldon Aronowitz

Date of Execution: May 4, 1998

Helmut Puchner

Date of Execution: May 5, 1998

Ravindra A. Kapre

Date of Execution: \_\_\_

May 5, 1998

James P. Kimball

Date of Execution: May 6, 1998

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**PATENT** REEL: 9390 FRAME: 0260



2.	Name	and	address	of	receiving	party(ies):

10.

LSI Logic Corporation 1551 McCarthy Boulevard Milpitas, California 95635 U.S.A.

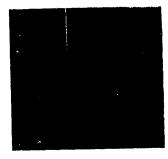
	U.S.A.						
3.	Nature of conveyance: Assignment						
4.	Application number(s) or patent number(s):  If this document is being filed together with a new application, the execution date of the application is:   May 4, 1998, May 5, 1998, May 5, 1998, and May 6, 1998.						
	A. Patent Application Serial Number:  B. Patent Number:						
5.	Name and address of party to whom correspondence concerning document should be mailed:						
	John P. Taylor Post Office Box 1598 Temecula, California 92593-1598 U.S.A.						
6.	Total number of applications and patents involved:1						
7.	Total fee (37 CFR 3.41): \$40.00.						
8.	Attached is a check in the amount of \$40.00.						
	Charge Deposit Account No in the amount of \$  (A duplicate copy of this document is enclosed.)						
9.	Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.  John P. Taylor  Reg. No. 22,369						
	Neg. 110. 22,307						

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Total number of pages including cover sheet, attachments and document: 3,

Witness: Witness: Printed Witness: Witness: Printed

Witness:



Docket No.: P-3584

Patent

## ASS'GNMENT

which has been executed by the undersigned concurrently herewith, which was filed on \_\_\_\_\_\_19\_\_\_ and assigned Serial No. \_\_\_\_

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/WE, the undersigned, Sheldon Aronowitz, Helmut Puchner, Ravindra A. Kapre, and James P. Kimball., do hereby sell, assign, and transfer to: LSI LOGIC CORPORATION, a corporation of Delawere, having a place of business at 1551 McCarthy Boulevard, Milpitas, California 95035, ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements which are disclosed in the application for United States Letters Patent,

and is entitled: "FORMATION OF INTEGRATED CIRCUIT STRUCTURE USING ONE OR MORE SILICON LAYERS FOR IMPLANTATION AND OUT-DIFFUSION IN FORMATION OF DEFECT-FREE SOURCE/DRAIN REGIONS AND ALSO FOR SUBSEQUENT FORMATION OF SILICON NITRIDE SPACERS" and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United

States and all foreign countries on any of said improvements; and in and to all origineen or shall be issued in the United States and all foreign countries on said improvements are the priority resulting from the filing of said United States application; and	ginal and reissued patents which have
Agree that said Assignee may apply for and receive Letters Patent for said improvement and continuing, substitute, renewal, reissue, and all other patent application execute all rightful oaths, assignments, powers of attorney and other patent applications, saigns, assigns, assigns, and representatives, all facts known to the undersigned reissue, and generally do everything possible which said Assignee, its succonsider desirable for aiding in securing and maintaining proper patent protection title to said improvements and all applications to patents and all patents on said successors, assigns and legal representatives; and	b, its successors, assigns and legal ment, the undersigned will execute all ons on any and all said improvements; communicate to said Assignee, its elating to said improvements and the essors, assigns or representatives shall for said improvements and for vesting
Covenant with said Assignee, its successors, assigns and legal representatives license, or other agreement affecting the rights and property herein convey undersigned, and that full right to convey the same as herein expressed is poss	ed has been made to others by the
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Name: Junes P. Kimbalt Date: Ylan (2 , 1998

PATENT REEL: 9390 FRAME: 0262

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